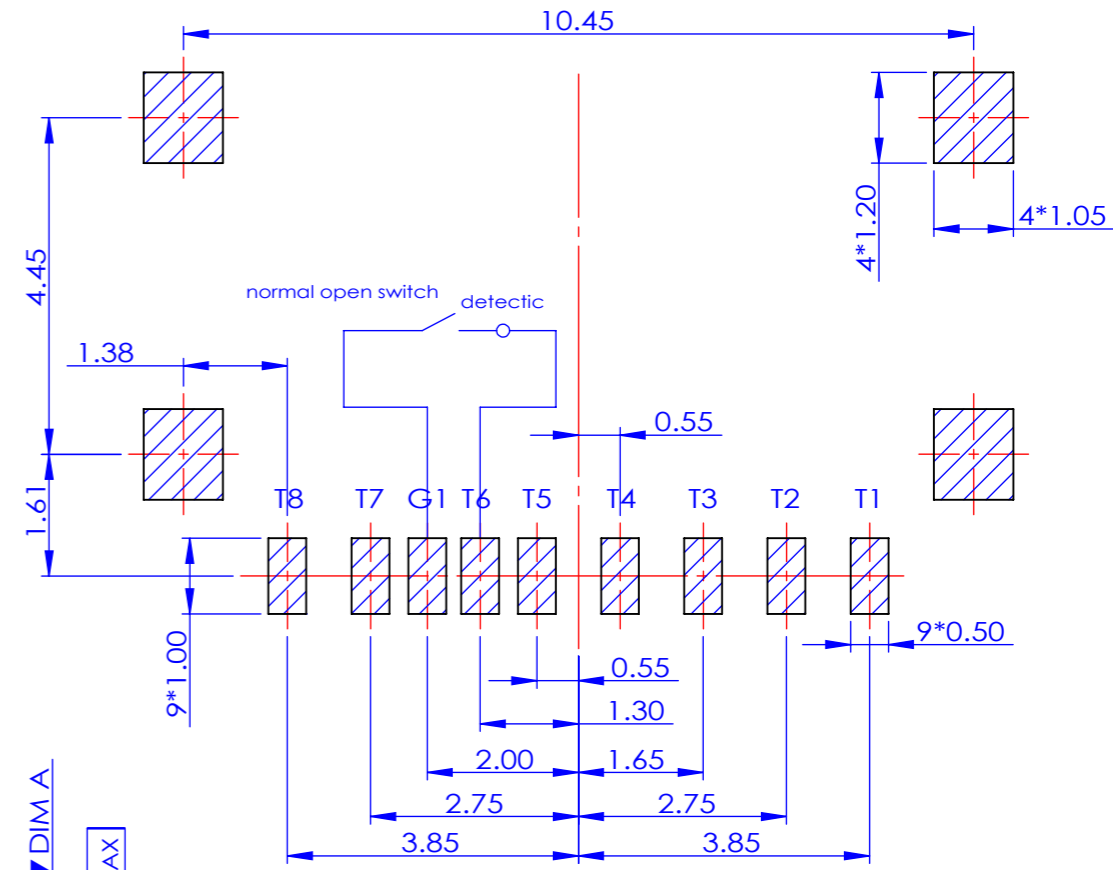
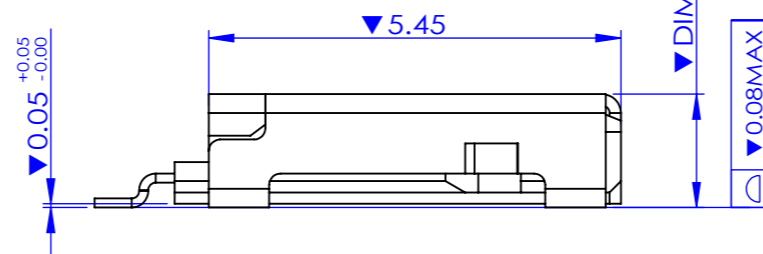


P/N	DIM A	高度标示
T11-BB09F130	1.35	13
T11-BB09F150	1.50	15
T11-BB09F170	1.70	17
T11-BB09F190	1.95	19



P.C.B LAYOUT (TOLERANCE:±0.05)

- NOTES:
- MATERIAL:
HOUSING:LCP,BLACK,UL 94V-0
CONTACT:PHOSPHOR BRONZE,T=0.12MM
SHELL:STAINLESS STEEL T=0.15MM
 - FINISH
CONTACT:
50U" NI MIN UNDER PLATED OVER ALL
Au: 1u"Min ON CONTACT AND SOLDER AREA
SHELL:
50U" NI MIN UNDER PLATED OVER ALL
Au: 1u"Min ON SOLDER TAIL AREA
 - ALL DIMENSIONS MARKED ▼ MUST BE CONTROLLED BY QC
 - RATED PARAMETERS OF CONNECTOR
4-1.Operating temperature: -40α to 70α
4-2.Rated Current: 0.5A
4-3.Rated Voltage: 30V DC Per Contact
 - ELECTRICAL MECHANICAL ENVIRONMENTAL
5-1.Dielectric withstanding Voltage : 500V AC 1min.
5-2.Insulation Resistance: 1000 MΩMin.
5-3.Normal Force: 30g Min. Per Pin
5-4.Durability: 3000 cycles
5-5.Contact Resistance: 50mΩ MAX.

T-CARD PIN NO.	PIN NO.
T1	DAT2
T2	CD/DAT3
T3	CMD
T4	VDD
T5	CLK
T6	VSS
T7	DAT0
T8	DAT1
G1	SWITCH

REV.	ECN NO.	DESCRIPTION	DATE	UNITS: mm	GENERAL TOLERANCE	DRAW:	PART NO:
B	E1508305A	增加高度标示	08/27/2015	DATE: 04/07/2015	X. ±0.20 .X ±0.15 SCALE: 10 / 1 .XX ±0.10 .XXX ±0.05	CHECKED:	T11-BB09FXX0
A	---	NEW	04/07/2015	SCALE: 10 / 1	X.° ±2.00° .X° ±1.00° .XX° ±0.50°	APPROVE:	TITLE: T-FLASH CARD 成品H=1.35&1.50&1.70mm&1.95mm
REV.	ECN NO.	DESCRIPTION	DATE	REV. B	MATERIAL: FINISH: SEE NOTE		DRAWING NO:

